

ORDER DESCRIPTION - PART II

1. Object of the contract

The subject of the contract is a manufacturing of ceramic board according to the customer's specification. The contractor will provide the following boards:

5 szt. Cer_proto

5 szt. PCB_interposer

5szt. SKP.012.006.2 - upper housing 2.2mm

5szt. SKP.012.007.2 - lower housing 0.4mm

2. Detailed scope of the subject

The documentation will provide to the contractor after sight NDA agreement:

- a) NC Drill
- b) Gerber

Technical specification:

Cer_proto (5 pcs)

- size: Ø24mm, round
- layers number: 1
- minimal space between paths: 0.1mm
- minimum paths length: 0.1mm
- core material: ceramic ALN **1mm thickness**
- without solder mask
- without description layer
- gold plating NEPIG

PCB_interposer (5 pcs)

- size: 32x38mm
- layers number: 2
- minimal space between paths: 0.2mm
- minimum paths length: 0.2mm
- core material: ceramic ALN **1mm thickness**
- without solder mask
- without description layer
- gold plating NEPIG

SKP.012.006.2 - upper housing 2.2mm (5 pcs)

- size: 30,7x38mm
- layers number: 0
- core material: ceramic ALN **2,2mm thickness**
- without solder mask
- without description layer

SKP.012.007.2 - lower housing 0.4mm (5 pcs)

- size: 30,7x38mm
- layers number: 0
- core material: ceramic ALN **0,4mm thickness**
- without solder mask
- without description layer

3. Additional information

- a. The boards are to be delivered individually not in panel.

4. CPV

31712310-6 Collectively printed board